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To the Honorable Commissioner



100738280

3 attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Takuya FUKUDA, Nobuyoshi KOBAYASHI, Yoshitaka  
NAKAMURA, Masayoshi SAITO, Shinichi FUKUDA,  
Yoshifumi KAWAMOTOAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

☐ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other \_\_\_\_\_

Execution Date: April 14, 15, 1998

## 2. Name and address of receiving party(ies)

Name: HITACHI LTD

Internal Address: \_\_\_\_\_

Street Address: 6, KANDA SURUGADAI 4-CHOME

CHIYODA-KU, TOKYO JAPAN

City: \_\_\_\_\_ State: \_\_\_\_\_ ZIP: \_\_\_\_\_

Additional name(s) & address(es) attached? ☐ Yes ☒ No

## 4. Application number(s) or patent number(s):

April 14, 15, 1998

If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: ANTONELLI, TERRY, STOUT &amp; KRAUS, LLP

04/28/1998 MCLAYBRO 00000021 09051978

05 Internal Address: \_\_\_\_\_

40.00 op

Street Address: 1300 NORTH SEVENTEENTH STREET

SUITE 1800

City: ARLINGTON State: VA ZIP: 22209

## 6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

## 8. Deposit account number:

01-2135

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ronald J. Shore

Name of Person Signing 28,577

Signature

April 24, 1998

Date

Total number of pages including cover sheet, attachments, and document: 2

# ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE  
AND PROCESS FOR MANUFACTURING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures :

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)	Witnesses (立会人サイン)
1) <u>Takuya Fukuda</u> Takuya Fukuda	April 14, 1998	<u>Yoshiaki Sudo</u>
2) <u>Nobuyoshi Kobayashi</u> Nobuyoshi Kobayashi	April 14, 1998	<u>Yoshiaki Sudo</u>
3) <u>Yoshitaka Nakamura</u> Yoshitaka Nakamura	April 14, 1998	<u>Yoshiaki Sudo</u>
4) <u>Masayoshi Saito</u> Masayoshi Saito	April 14, 1998	<u>Yoshiaki Sudo</u>
5) <u>Shinichi Fukada</u> Shinichi Fukada	April 15, 1998	<u>Yoshiaki Sudo</u>
6) <u>Yoshifumi Kawamoto</u> Yoshifumi Kawamoto	April 15, 1998	<u>Yoshiaki Sudo</u>
7) _____	_____	_____
8) _____	_____	_____
9) _____	_____	_____
10) _____	_____	_____

PATENT

RECORDED: 04/24/1998

REEL: 9232 FRAME: 0361